

1-17.02

Atty. Docket No. AMAT/5908/CPI/AL WIRE/PJS

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Box Patent Application Assistant Commissioner of Patents and Trademarks Washington, D.C. 20231

Re:

Inventor(s):

HOUGONG WANG; KENNY KING-TAI NGAN and ZHENG XU

Title:

SEMICONDUCTOR WAFER PREHEATING

Transmitted herewith is the patent application identified above, including:

Χ	Specification,	claims	and abstract,	totaling	27	pages

- X Drawings totaling 5 pages, X Formal ____ Informal.
- X Executed Declaration and Power of Attorney.
- Information Disclosure Statement w/ Form 1449 and References.
- \underline{X} Assignment of the invention to **Applied Materials, Inc.**

X Assignment Recordation Cover Sheet

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FEE CALCULATION										
Fee Items	Claims Filed	Included With Basic Fee	Extra Claims	Fee Rate	Total					
Total Claims	64	-20=	44	x \$18.00	\$792.00					
Independent Claims	4	-3=	1	x \$84.00	\$ 84.00					
Basic Filing Fee	\$ 740.00									
TOTAL FEES	\$1,616.00									

- X The Commissioner is hereby authorized to charge \$1,616.00 to Deposit Account No. 50-1074/5908/CPI/AL WIRE/PJS.
- The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account No. <u>50-1074/5908/CPI/AL WIRE/PJS</u>. A duplicate copy of this transmittal is enclosed.
- X Please address all future correspondence to:

PATENT COUNSEL
APPLIED MATERIALS, INC.
Legal Affairs Department
P.O.BOX 450A

Santa Clara, CA. 95052

I hereby certify that this correspondence is being deposited with the United States Postal Service as express mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231.

Everess Mail Recent No. El 849164562LIS

Date of Denosit 1-14-02

Supporter Self Malaka

Robert W. Mulcahy/ Registration No. 25/436

Respectfully submitted,

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